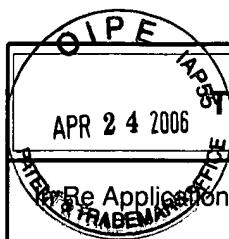


IFC



# TRANSMITTAL OF FORMAL DRAWINGS

Docket No.

YOR920030262US1 (16785)

Re Application Of: Daniel C. Edelstein et al.

Application No.	Filing Date	Examiner	Customer No.	Group Art Unit	Confirmation No.
10/662,022	September 12, 2003	Alexander G. Ghyka	23389	2812	8703

Invention: **STRUCTURES WITH IMPROVED INTERFACIAL STRENGTH OF SiCOH DIELECTRICS AND METHOD FOR PREPARING THE SAME**

Address to:  
**Commissioner for Patents**  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Transmitted herewith are:

3 sheets of formal drawing(s) for this application.

- Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c).

Signature

Leslie S. Szivos, Ph.D.

Registration No. 39,394

SCULLY, SCOTT, MURPHY & PRESSER, P.C.  
 400 Garden City Plaza - Suite 300  
 Garden City, New York 11530

Dated: April 19, 2006

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on

April 19, 2006

(Date)

Signature of Person Mailing Correspondence

Leslie S. Szivos, Ph.D.

Typed or Printed Name of Person Mailing Correspondence